FAIRCHILD

74LVTH16501 Low Voltage 18-Bit Universal Bus Transceivers with Bushold and 3-STATE Outputs

General Description

Features

- Input and output interface capability to systems at $5V V_{CC}$
- Bushold data inputs eliminate the need for external pull-up resistors to hold unused inputs
- Live insertion/extraction permitted
- Power up/down high impedance provides glitch-free bus loading
- Outputs source/sink -32 mA/+64 mA
- Functionally compatible with the 74 series 16501
- ESD Performance: Human-Body Model > 2000V
- Machine Model > 200V Charged-Device Model > 1000V

Ordering Code:

FAIRCH			March 2001 Revised March 2001
	age 18-Bi	t Universa 3-STATE C	l Bus Transceivers Outputs
combining D-type data flow in transpo- Data flow in <u>each</u> (OEAB and OEBA clock (CLKAB and The LVTH16501 of the need for extering inputs. The transceiver is applications, but we face to a 5V envi- with an advanced	is an 18-bit univers latches and D-type arent, latched, and c direction is controlle .), latch-enable (LEA	e flip-flops to allow locked modes. ed by output-enable AB and LEBA), and pushold, eliminating rrs to hold unused voltage (3.3V) V _{CC} provide a TTL inter- 16501 is fabricated gy to achieve high	 Features Input and output interface capability to systems at 5V V_{CC} Bushold data inputs eliminate the need for external pull-up resistors to hold unused inputs Live insertion/extraction permitted Power up/down high impedance provides glitch-free bus loading Outputs source/sink -32 mA/+64 mA Functionally compatible with the 74 series 16501 ESD Performance: Human-Body Model > 2000V Machine Model > 200V Charged-Device Model > 1000V
Order Number Order Number 4LVTH16501MEA 4LVTH16501MTD Devices also available i	Package Number MS56A MTD56		Package Description I Outline Package (SSOP), JEDEC MO-118, 0.300 Wide Small Outline Package (TSSOP), JEDEC MO-153, 6.1mm Wide "X" to the ordering code.

Connection Diagram

		\bigcirc		
OEAB —	1		56	— GND
LEAB —	2		55	— CLKAE
A ₁ -	3		54	— В ₁
GND —	4		53	— GND
A2	5		52	— в ₂
A3 —	6		51	— B ₃
v _{cc} —	7		50	-v _{cc}
A4	8		49	— В ₄
A ₅ —	9		48	— B ₅
A ₆ —	10		47	— B ₆
GND —	11		46	— GND
A ₇ —	12		45	— В ₇
A ₈ —	13		44	— В ₈
A ₉ —	14		43	— В ₉
A ₁₀ —	15		42	— B ₁₀
A ₁₁ -	16		41	— B ₁₁
A ₁₂	17		40	-B ₁₂
GND —	18		39	— GND
A ₁₃ —	19		38	— B ₁₃
A ₁₄ —	20		37	— B ₁₄
A ₁₅ —	21		36	— B ₁₅
v _{cc} —	22		35	-v _{cc}
A ₁₆ —	23		34	— B ₁₆
A ₁₇ —	24		33	— B ₁₇
GND —	25		32	— GND
A ₁₈ -	26		31	- B ₁₈
OEBA -	27		30	— CLKBA
LEBA —	28		29	- GND

Pin Descriptions

Pin Names	Description
A ₁ -A ₁₈	Data Register A Inputs/3-STATE Outputs
B ₁ -B ₁₈	Data Register B Inputs/3-STATE Outputs
CLKAB, CLKBA	Clock Pulse Inputs
LEAB, LEBA	Latch Enable Inputs
OEAB, OEBA	Output Enable Inputs

Function Table (Note 1)

	Inp	outs		Output
OEAB	LEAB	CLKAB	An	B _n
L	Х	Х	Х	Z
Н	Н	Х	L	L
н	н	Х	н	н
н	L	Ŷ	L	L
н	L	↑	н	н
н	L	н	Х	B ₀ (Note 2)
н	L	L	Х	B ₀ (Note 2) B ₀ (Note 3)

H = HIGH Voltage Level L = LOW Voltage Level X = Immaterial $\uparrow = LOW-to-HIGH Clock Transition$ Z = High Impedance

Note 1: A-to-B data flow is shown: B-to-A flow is similar but uses OEBA, LEBA, and CLKBA. OEBA is active LOW

Note 2: Output level before the indicated steady-state input conditions were established, provided that CLKAB was HIGH before LEAB went LOW. Note 3: Output level before the indicated steady-state input conditions were established.

Functional Description

For A-to-B data flow, the device operates in the transparent mode when LEAB is HIGH. When LEAB is LOW, the A data is latched if CLKAB is held at a HIGH or LOW logic level. If LEAB is LOW, the A bus data is stored in the latch/ flip-flop on the LOW-to-HIGH transition of CLKAB. Outputenable OEAB is active-HIGH. When OEAB is HIGH, the outputs are active. When OEAB is LOW, the outputs are in the high-impedance state.

Data flow for B to A is similar to that of A-to-B but uses plementary (OEAB is active-HIGH and OEBA is active-LOW). OEBA, LEBA, and CLKBA. The output enables are com-





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Symbol	Parameter	Value	Conditions	Units
V _{CC}	Supply Voltage	-0.5 to +4.6		V
VI	DC Input Voltage	-0.5 to +7.0		V
Vo	DC Output Voltage	-0.5 to +7.0	Output in 3-STATE	V
		-0.5 to +7.0	Output in HIGH or LOW State (Note 5)	V
I _{IK}	DC Input Diode Current	-50	V _I < GND	mA
I _{ок}	DC Output Diode Current	-50	V _O < GND	mA
0	DC Output Current	64	V _O > V _{CC} Output at HIGH State	mA
		128	V _O > V _{CC} Output at LOW State	mA
I _{CC}	DC Supply Current per Supply Pin	±64		mA
I _{GND}	DC Ground Current per Ground Pin	±128		mA
T _{STG}	Storage Temperature	-65 to +150		°C

Recommended Operating Conditions Symbol Parameter Min Max Units 2.7 V_{CC} Supply Voltage 3.6 V Input Voltage V VI 0 5.5 I_{OH} HIGH-Level Output Current -32 mΑ I_{OL} LOW-Level Output Current 64 mΑ T_A Free-Air Operating Temperature -40 85 °C $\Delta t / \Delta V$ Input Edge Rate, $V_{IN} = 0.8V-2.0V$, $V_{CC} = 3.0V$ 0 10 ns/V

Note 4: Absolute Maximum continuous ratings are those values beyond which damage to the device may occur. Exposure to these conditions or conditions beyond those indicated may adversely affect device reliability. Functional operation under absolute maximum rated conditions is not implied.

Note 5: I_O Absolute Maximum Rating must be observed.

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74LVTH16501

DC Electrical Characteristics

0	Baramatar		V_{CC} $T_A = -40$		C to +85°C	Unite	Osmalitisma	
Symbol	Parameter		(V)	Min	Max	Units	Conditions	
V _{IK}	Input Clamp Diode Voltage		2.7		-1.2	V	I _I = -18 mA	
V _{IH}	Input HIGH Voltage		2.7–3.6	2.0		V	$V_0 \le 0.1V$ or	
V _{IL}	Input LOW Voltage		2.7–3.6		0.8	v	$V_O \ge V_{CC} - 0.1V$	
V _{OH}	Output HIGH Voltage		2.7–3.6	V _{CC} - 0.2		V	I _{OH} = -100 μA	
			2.7	2.4		V	I _{OH} = -8 mA	
			3.0	2.0		V	I _{OH} = -32 mA	
V _{OL}	Output LOW Voltage		2.7		0.2	V	I _{OL} = 100 μA	
			2.7		0.5	V	I _{OL} = 24 mA	
			3.0		0.4	V	I _{OL} = 16 mA	
			3.0		0.5	V	I _{OL} = 32 mA	
		-	3.0		0.55	V	I _{OL} = 64 mA	
I _{I(HOLD)}	Bushold Input Minimum Drive		3.0	75		μΑ	V _I = 0.8V	
			5.0	-75		μA	V _I = 2.0V	
I _{I(OD)}	Bushold Input Over-Drive		3.0	500		μΑ	(Note 6)	
	Current to Change State		5.0	-500		μΑ	(Note 7)	
l _l	Input Current		3.6		10	μΑ	V _I = 5.5V	
		Control Pins	3.6		±1	μΑ	$V_I = 0V \text{ or } V_{CC}$	
		Data Dine	Data Pins 3.6		-5	μΑ	$V_I = 0V$	
		Dala Filis			1	μΑ	$V_I = V_{CC}$	
I _{OFF}	Power Off Leakage Current		0		±100	μΑ	$0V \le V_1 \text{ or } V_0 \le 5.5V$	
I _{PU/PD}	Power up/down 3-STATE		0–1.5V		±100	μA	V _O = 0.5V to 3.0V	
	Output Current		0-1.50		100	μΑ	$V_I = GND \text{ or } V_{CC}$	
I _{OZL}	3-STATE Output Leakage Cu	rrent	3.6		-5	μΑ	$V_{0} = 0.0V$	
I _{OZH}	3-STATE Output Leakage Cu	rrent	3.6		5	μΑ	V _O = 3.6V	
I _{OZH} +	3-STATE Output Leakage Cu	rrent	3.6		10	μΑ	$V_{CC} < V_O \le 5.5V$	
I _{CCH}	Power Supply Current		3.6		0.19	mA	Outputs HIGH	
I _{CCL}	Power Supply Current		3.6		5	mA	Outputs LOW	
I _{CCZ}	Power Supply Current		3.6		0.19	mA	Outputs Disabled	
I _{CCZ} +	Power Supply Current		3.6		0.19	mA	$V_{CC} \le V_O \le 5.5V$,	
							Outputs Disabled	
ΔI _{CC}	Increase in Power Supply Cu	rrent	3.6		0.2	mA	One Input at V _{CC} – 0.6V	
	(Note 8)					1	Other Inputs at V _{CC} or G	

Note 6: An external driver must source at least the specified current to switch from LOW-to-HIGH.

Note 7: An external driver must sink at least the specified current to switch from HIGH-to-LOW.

Note 8: This is the increase in supply current for each input that is at the specified voltage level rather than V_{CC} or GND.

Dynamic Switching Characteristics (Note 9)

Symbol	Parameter	V _{cc}		$T_A = 25^\circ C$		Units	Conditions
Symbol	Falantelei	(V)	Min	Тур	Max	Units	$\textbf{C}_{\textbf{L}}=\textbf{50}~\textbf{pF},~\textbf{R}_{\textbf{L}}=\textbf{500}\Omega$
V _{OLP}	Quiet Output Maximum Dynamic V _{OL}	3.3		0.8		V	(Note 10)
V _{OLV}	Quiet Output Minimum Dynamic V _{OL}	3.3		-0.8		V	(Note 10)

Note 9: Characterized in SSOP package. Guaranteed parameter, but not tested.

Note 10: Max number of outputs defined as (n). n–1 data inputs are driven 0V to 3V. Output under test held LOW.

			T _A = -40°	1			
Symbol	F	Parameter	V _{CC} = 3.	$.3\pm0.3V$	$V_{CC} = 2.7V$		Units
			Min	Max	Min	Max	1
МАХ	CLKAB or CLKBA to B or A		150		150		MHz
PLH	Propagation Delay		1.3	5.1	1.3	5.6	
PHL	Data to Outputs		1.3	4.7	1.3	5.3	ns
PLH	Propagation Delay		1.5	5.5	1.5	6.1	
PHL	LEBA or LEAB to B or A		1.5	5.1	1.5	5.7	ns
PLH	Propagation Delay		1.3	56	1.3	6.2	
PHL	CLKBA or CLKAB to B or A		1.3	5.1	1.3	5.7	ns
t _{PZH}	Output Enable Time		1.3	4.9	1.3	5.6	
PZL			1.3	5.4	1.3	6.2	ns
^t PHZ	Output Disable Time		1.7	5.9	1.7	6.6	
PLZ	Calpar Bioabio Timo		1.7	5.8	1.7	6.3	ns
S	Setup Time	A before CLKAB	2.1	0.0	2.4	0.0	
5		B before CLKBA	2.1		2.4		-
		A or B before LE, CLK HIGH	2.1		1.6		ns
		A or B before LE, CLK LOW	2.4		1.6		4
	Hold Time	A or B before LE, CLK LOW A or B after CLK	1.0		1.6		
н	Hold Time						ns
	Dulas Mistik	A or B after LE	1.7		1.7		
tw	Pulse Width	LE HIGH	3.3		3.3		ns
		CLK HIGH or LOW	3.3	4.0	3.3		
OSLH	Output to Output Skew (Note	11)		1.0 1.0		1.0 1.0	ns
Symbol	Parameter Input Capacitance	Cond V _{CC} = 0V, V _I = 0V or V			Typical 4		Units pF
'IN 1/O	Input/Output Capacitance	$V_{CC} = 3.0V, V_0 = 0V o$					рі
Note 12: Ca	apacitance is measured at frequer	ncy f = 1 MHz, per MIL-STD-883, Method 30			8		pF





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